INTEGRATED CIRCUITS

DATA SHEET

TDA7056 3 W mono BTL audio output amplifier

Product specification
File under Integrated Circuits, IC01

May 1992





TDA7056

FEATURES

- · No external components
- No switch-on/off clicks
- Good overall stability
- Low power consumption
- · Short circuit proof
- ESD protected on all pins.

GENERAL DESCRIPTION

The TDA7056 is a mono output amplifier contained in a 9 pin medium power package.

The device is designed for battery-fed portable mono recorders, radios and television.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	supply voltage		3	11	18	V
Po	output power in 16 Ω	V _P = 11 V	2.5	3	_	w
G _V	internal voltage gain		39	40.5	42	dB
l _P	total quiescent current	V _P = 11 V;	_	5	7	mA
,		R _L = ∞				
THD	total harmonic distortion	P _O = 0.5 W	-	0.25	1	%

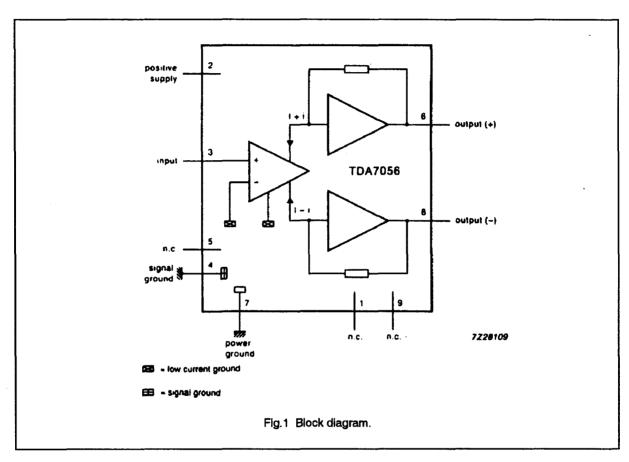
ORDERING INFORMATION

EXTENDED		PACKAGE	,	
TYPE NUMBER	PINS	PIN POSITION	MATERIAL	CODE
TDA7056	9	SIL	plastic	SOT110 ⁽¹⁾

Note

1. SOT110-1; 1996 August 21.

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PINNING

PIN	DESCRIPTION
1	n.c.
2	V _P
3	input (+)
4	signal ground
5	n.c.
6	output (+)
7	power ground
8	output (–)
9	n.c.

FUNCTIONAL DESCRIPTION

The TDA7056 is a mono output amplifier, designed for battery-fed portable radios and mains-fed equipment such as television. For space reasons there is a trend to decrease the number of external components. For portable applications there is also a trend to decrease the number of battery cells, but still a reasonable output power is required.

The TDA7056 fulfills both of these requirements. It needs no peripheral components, because it makes use of the Bridge-Tied-Load (BTL) principle. Consequently it has, at the same supply voltage, a higher output power compared to a conventional Single Ended output stage. It delivers an output power of 1 W into a loudspeaker load of 8 Ω with 6 V supply or 3 W into 16 Ω loudspeaker at 11 V without need of an external heatsink. The gain is internally fixed at 40 dB. Special attention is given to switch-on/off click suppression, and it has a good overall stability. The load can be short circuited at all input conditions.

TDA7056

LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _P	supply voltage		Ì-	18	V
IORM	Peak output current repetitive		_	1	Α
I _{OSM}	Peak output current non-repetitive		-	1.5	Α
T _{stg}	storage temperature range		-55	150	°C
τ _i	junction temperature		-	150	°C
Ptot	total power dissipation	T _{case} < 60 °C	_	9	w
T _{sc}	short circuiting time	see note 1	_	1	hr

Note

THERMAL RESISTANCE

SYMBOL	PARAMETER	NOM.	UNIT
R _{th j-c}	from junction to case	10	K/W
R _{th j-a}	from junction to ambient in free air	55	K/W

POWER DISSIPATION

Assume: $V_P = 11 \text{ V}$; $R_L = 16 \Omega$.

The maximum sine-wave dissipation is 1.52 W.

The R_{th j-a} of the package is 55 K/W. T_{amb} max = 150 - 55 x 1.52 = 66.4 °C.

^{1.} The load can be short-circuited at all input conditions.

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CHARACTERISTICS

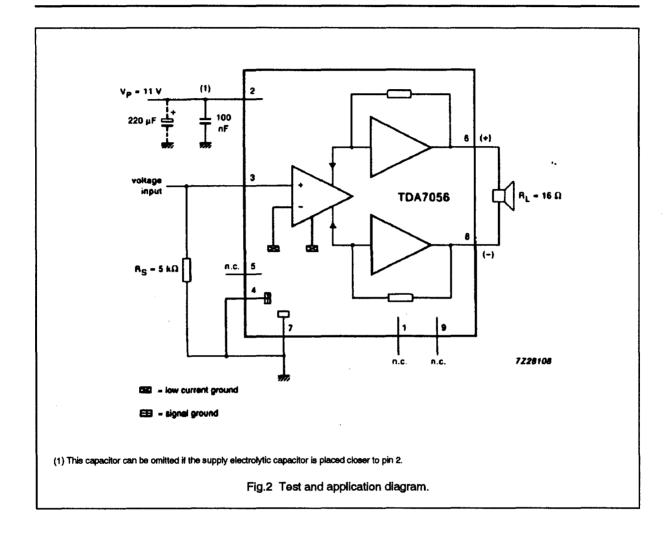
At T_{amb} = 25 °C; f = 1 kHz; V_P = 11 V; R_L = 16 Ω (see Fig.2).

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	operating supply voltage		3	11	18	V
IORM	repetitive peak output current		_	Ī-	0.6	Α
lР	total quiescent current	note 1	_	5	7	mA
		R _L = ∞				
Po	output power	THD = 10%	2.5	3	-	W
THD	total harmonic distortion	$P_0 = 0.5 W$	-	0.25	1	%
G _v	voltage gain		39	40.5	42	dB
V _{no}	noise output voltage	note 2	-	180	300	μV
V _{no}	noise output voltage	note 3	_	60	_	μV
	frequency response			20 to 20.000	_	Hz
RR	ripple rejection	note 4	36	50	_	dB
ΔV	DC-output offset voltage	note 5	_	_	200	mV
Z _i	input impedance		_	100	-	kΩ
l _i	input bias current		_	100	300	nA

Notes to the characteristics

- 1. With a load connected to the outputs the quiescent current will increase, the maximum value of this increase being equal to the DC output offset voltage divided by R_L.
- 2. The noise output voltage (RMS value) is measured with R_S = 5 k Ω unweighted (20 Hz to 20 kHz).
- 3. The noise output voltage (RMS value) at f = 500 kHz is measured with R_S = 0 Ω and bandwidth = 5 kHz. With a practical load (R_L = 16 Ω , L_L = 200 μ H) the noise output current is only 50 nA.
- 4. The ripple rejection is measured with $R_S=0~\Omega$ and f=100~Hz to 10 kHz. The ripple voltage (200 mV) is applied to the positive supply rail.
- 5. $R_S = 5 k\Omega$.

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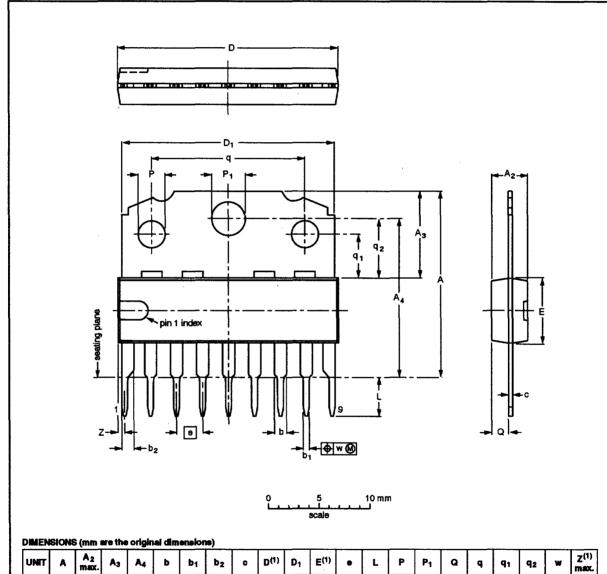
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TDA7056

PACKAGE OUTLINE

SIL9MPF: plastic single in-line medium power package with fin; 9 leads

SOT110-1



UNIT	A	A ₂ max.	A ₃	Ą	۵	b ₁	b ₂	o	D(1)	D ₁	E ⁽¹⁾	•	L	P	P ₁	đ	q	q ₁	q ₂	*	Z ⁽¹⁾ max.
mm	18.5 17.8	3.7	8.7 8.0	15.8 15.4	1.40 1.14	0.67 0.50		0.48 0.38	21.8 21.4	21.4 20.7	6.48 6.20	2.54	3.9 3.4	2.75 2.50	3.4 3.2	1.75 1.55		4.4 4.2	5.9 5.7	0.25	1.0

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT110-1					92-11-17 95-02-25	

TDA7056

SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

Soldering by dipping or by wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature (T_{stg max}). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Repairing soldered joints

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
more of the limiting values of the device at these or at	n accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or may cause permanent damage to the device. These are stress ratings only and operation any other conditions above those given in the Characteristics sections of the specification limiting values for extended periods may affect device reliability.
Application information	
Where application informat	tion is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

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Description

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Features

- No external components
- No switch-on/off clicks
- Good overall stability
- Low power consumption
- Short circuit proof
- ESD protected on all pins.

Datasheet

Type number	<u>Title</u>	Publication release date	<u>Datasheet status</u>	Page count	File size (kB)	Datasheet
TDA7056	3 W mono BTL audio output amplifier	01-May-92	Product Specification	8	45	Download

Blockdiagram(s)

Block diagram of tda7056/n2

Parametrics

Type number Package REMARKS Supply voltage (V)typ.

TDA7056/N2 SOT110-1 (SIL9MPF) no peripheral components 3 to 18

Products, packages, availability and ordering

Type number	North American Type number		marking/packing IC packing info	package	device status	buy online
TDA7056/N2	TDA7056U	9351 648 10112	Standard Marking * Tube	<u>SOT110-1</u> (SIL9MPF)	Full production	order this

Products in the above table are all in production. Some variants are discontinued; <u>click here</u> for information on these variants.

Find similar products:

<u>TDA7056</u> links to the similar products page containing an overview of products that are similar in function or related to the Type number(s) as listed on this page. The similar products page includes products from the same catalog tree(s), relevant selection guides and products from the same functional category.

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